

**Silicon Carbide Metal-Oxide-Semiconductor Field-Effect Transistor  
1200V N-Channel SiC MOSFET**

Bonding Pad Information		Chip Information	
		Die Size (with Scribe Line)	3,430μm x 3,000μm
		Gate Pad Size	500μm x 500μm
		Source Pad Size	Full metallized surface of source region
		Scribe Line Size	80μm
		Wafer Size	6inches
		Wafer Thickness	175±15um
Metallization	Front Side	Al/Cu : 4μm	
	Back Side	Ti/Ni/Ag : 2.5μm	
Recommended Wire Bonding			
	Gate Pad	5.0 mil x 1 (Al wire)	
	Source Pad	20 mil x 2 (Al wire)	
	Gross Die	1,498ea	

**Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	1200	V
Gate-Source Voltage	V <sub>GS,op</sub>	-5/+20	V
Drain Current-Continuous @ T <sub>c</sub> =25°C	I <sub>D</sub>	47	A
Drain Current-Pulsed	I <sub>DM</sub>	70	A
Operating Junction Temperature Range	T <sub>J</sub>	-55 to +175	°C

**Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>OFF CHARACTERISTIC</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =100uA	1200	-	-	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =1200V	-	1	100	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	-	10	250	nA
<b>ON CHARACTERISTIC</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =5mA	1.8	2.8	3.8	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =20V, I <sub>D</sub> =20A	-	70	95	mΩ
		V <sub>GS</sub> =18V, I <sub>D</sub> =20A	-	82	107	
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =1000V, f=1MHz, V <sub>AC</sub> =25mV	-	1450	-	pF
Output Capacitance	C <sub>oss</sub>		-	66	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	13	-	
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =-5V, I <sub>s</sub> =10A	-	4.9	-	V

**NOTE:**

- The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
- R<sub>DS(ON)</sub> calculated by TO-247-3L package type.